

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Gurtej S. Sandhu

**Serial No.:** 09/023,146

**Filed:** February 12, 1998

**For:** TUNGSTEN SILICIDE (WSIX)  
DEPOSITION PROCESS FOR  
SEMICONDUCTOR MANUFACTURE

**Confirmation No.:** 6553

**Examiner:** W. Coleman

**Group Art Unit:** 2823

**Attorney Docket No.:** 2269-3369.1US  
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**Notice of Allowance Mailed:**

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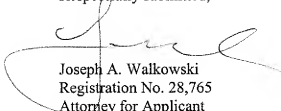
Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

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2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



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